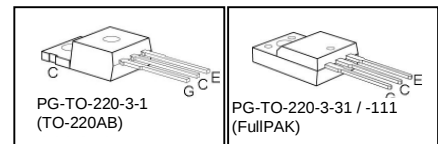
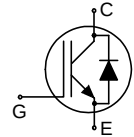


Fast IGBT in NPT-technology with soft, fast recovery anti-parallel Emitter Controlled Diode

- 75% lower  $E_{off}$  compared to previous generation combined with low conduction losses
- Short circuit withstand time – 10  $\mu$ s
- Designed for: Motor controls, Inverter
- NPT-Technology for 600V applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability
- Very soft, fast recovery anti-parallel Emitter Controlled Diode
- Isolated TO-220, 2.5kV, 60s
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC<sup>1</sup> for target applications
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



| Type     | $V_{CE}$ | $I_C$ | $V_{CE(sat)}$ | $T_j$ | Marking | Package               |
|----------|----------|-------|---------------|-------|---------|-----------------------|
| SKP06N60 | 600V     | 6A    | 2.3V          | 150°C | K06N60  | PG-TO-220-3-1         |
| SKA06N60 | 600V     | 5A    | 2.3V          | 150°C | K06N60  | PG-TO-220-3-31 / -111 |

<sup>1</sup> J-STD-020 and JEDEC-022

## Maximum Ratings

| Parameter                                                                             | Symbol            | Value      |            | Unit             |
|---------------------------------------------------------------------------------------|-------------------|------------|------------|------------------|
|                                                                                       |                   | SKP06N60   | SKA06N60   |                  |
| Collector-emitter voltage                                                             | $V_{CE}$          | 600        | 600        | V                |
| DC collector current                                                                  | $I_C$             |            |            | A                |
| $T_C = 25^\circ\text{C}$                                                              |                   | 12         | 9          |                  |
| $T_C = 100^\circ\text{C}$                                                             |                   | 6.9        | 5.0        |                  |
| Pulsed collector current, $t_p$ limited by $T_{jmax}$                                 | $I_{Cpuls}$       | 24         | 24         |                  |
| Turn off safe operating area $V_{CE} \leq 600\text{V}$ , $T_j \leq 150^\circ\text{C}$ | -                 | 24         | 24         |                  |
| Diode forward current                                                                 | $I_F$             |            |            |                  |
| $T_C = 25^\circ\text{C}$                                                              |                   | 12         | 12         |                  |
| $T_C = 100^\circ\text{C}$                                                             |                   | 6          | 6          |                  |
| Diode pulsed current, $t_p$ limited by $T_{jmax}$                                     | $I_{Fpuls}$       | 24         | 24         |                  |
| Gate-emitter voltage                                                                  | $V_{GE}$          | $\pm 20$   | $\pm 20$   | V                |
| Short circuit withstand time <sup>2</sup>                                             | $t_{SC}$          |            |            | $\mu\text{s}$    |
| $V_{GE} = 15\text{V}$ , $V_{CC} \leq 600\text{V}$ , $T_j \leq 150^\circ\text{C}$      |                   | 10         | 10         |                  |
| Power dissipation                                                                     | $P_{tot}$         |            |            | W                |
| $T_C = 25^\circ\text{C}$                                                              |                   | 68         | 32         |                  |
| Mounting Torque, Screw: M2.5 (Fullpak), M3 (TO220) <sup>3</sup>                       | $M$               | 0.6        | 0.5        | Nm               |
| Operating junction and storage temperature                                            | $T_j$ , $T_{stg}$ | -55...+150 | -55...+150 | $^\circ\text{C}$ |
| Soldering temperature                                                                 | $T_s$             | 260        | 260        | $^\circ\text{C}$ |
| wavesoldering, 1.6 mm (0.063 in.) from case for 10s                                   |                   |            |            |                  |

<sup>2</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

<sup>3</sup> Maximum mounting processes: 3

#### Thermal Resistance

| Parameter                                    | Symbol      | Conditions                           | Max. Value |          | Unit |
|----------------------------------------------|-------------|--------------------------------------|------------|----------|------|
|                                              |             |                                      | SKP06N60   | SKA06N60 |      |
| Characteristic                               |             |                                      |            |          |      |
| IGBT thermal resistance,<br>junction – case  | $R_{thJC}$  |                                      | 1.85       | 3.9      | K/W  |
| Diode thermal resistance,<br>junction – case | $R_{thJCD}$ |                                      | 3.5        | 5.0      |      |
| Thermal resistance,<br>junction – ambient    | $R_{thJA}$  | PG-TO-220-3-1<br>PG-TO220-3-31 /-111 | 62         | 65       |      |

#### Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | Typ. | max. |      |

#### Static Characteristic

|                                      |               |                                                    |     |      |      |         |
|--------------------------------------|---------------|----------------------------------------------------|-----|------|------|---------|
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE}=0V, I_C=500\mu A$                          | 600 | -    | -    | V       |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $V_{GE} = 15V, I_C=6A$<br>$T_j=25^\circ\text{C}$   | 1.7 | 2.0  | 2.4  |         |
|                                      |               | $T_j=150^\circ\text{C}$                            | -   | 2.3  | 2.8  |         |
| Diode forward voltage                | $V_F$         | $V_{GE}=0V, I_F=6A$<br>$T_j=25^\circ\text{C}$      | 1.2 | 1.4  | 1.8  |         |
|                                      |               | $T_j=150^\circ\text{C}$                            | -   | 1.25 | 1.65 |         |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C=250\mu A, V_{CE}=V_{GE}$                      | 3   | 4    | 5    |         |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE}=600V, V_{GE}=0V$<br>$T_j=25^\circ\text{C}$ | -   | -    | 20   | $\mu A$ |
|                                      |               | $T_j=150^\circ\text{C}$                            | -   | -    | 700  |         |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE}=0V, V_{GE}=20V$                            | -   | -    | 100  | nA      |
| Transconductance                     | $g_{fs}$      | $V_{CE}=20V, I_C=6A$                               | -   | 4.2  | -    | S       |

#### Dynamic Characteristic

|                                                                   |             |                                                                                       |   |     |     |    |
|-------------------------------------------------------------------|-------------|---------------------------------------------------------------------------------------|---|-----|-----|----|
| Input capacitance                                                 | $C_{iss}$   | $V_{CE}=25V,$<br>$V_{GE}=0V,$<br>$f=1\text{MHz}$                                      | - | 350 | 420 | pF |
| Output capacitance                                                | $C_{oss}$   |                                                                                       | - | 38  | 46  |    |
| Reverse transfer capacitance                                      | $C_{rss}$   |                                                                                       | - | 23  | 28  |    |
| Gate charge                                                       | $Q_{Gate}$  | $V_{CC}=480V, I_C=6A$<br>$V_{GE}=15V$                                                 | - | 32  | 42  | nC |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from case | $L_E$       |                                                                                       | - | 7   | -   | nH |
| Short circuit collector current <sup>2)</sup>                     | $I_{C(SC)}$ | $V_{GE}=15V, t_{SC}\leq 10\mu s$<br>$V_{CC}\leq 600V,$<br>$T_j\leq 150^\circ\text{C}$ | - | 60  | -   | A  |

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

**Switching Characteristic, Inductive Load, at  $T_j=25^\circ\text{C}$**

| Parameter              | Symbol       | Conditions                                                                                                                                                                                                                                                    | Value |       |       | Unit |
|------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|-------|------|
|                        |              |                                                                                                                                                                                                                                                               | min.  | typ.  | max.  |      |
| IGBT Characteristic    |              |                                                                                                                                                                                                                                                               |       |       |       |      |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=25^{\circ}\text{C}$ ,<br>$V_{CC}=400\text{V}$ , $I_C=6\text{A}$ ,<br>$V_{GE}=0/15\text{V}$ ,<br>$R_G=50\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=250\text{pF}$<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -     | 25    | 30    | ns   |
| Rise time              | $t_r$        |                                                                                                                                                                                                                                                               | -     | 18    | 22    |      |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                                                                                               | -     | 220   | 264   |      |
| Fall time              | $t_f$        |                                                                                                                                                                                                                                                               | -     | 54    | 65    |      |
| Turn-on energy         | $E_{on}$     |                                                                                                                                                                                                                                                               | -     | 0.110 | 0.127 | mJ   |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                                                                                               | -     | 0.105 | 0.137 |      |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                                                                                               | -     | 0.215 | 0.263 |      |

**Anti-Parallel Diode Characteristic**

|                                                                  |              |                                                                                                        |   |     |   |                  |
|------------------------------------------------------------------|--------------|--------------------------------------------------------------------------------------------------------|---|-----|---|------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_j=25^\circ\text{C}$ ,<br>$V_R=200\text{V}$ , $I_F=6\text{A}$ ,<br>$di_F/dt=200\text{A}/\mu\text{s}$ | - | 200 | - | ns               |
|                                                                  | $t_S$        |                                                                                                        | - | 17  | - |                  |
|                                                                  | $t_F$        |                                                                                                        | - | 183 | - |                  |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                        | - | 200 | - | nC               |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                        | - | 2.8 | - | A                |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |                                                                                                        | - | 180 | - | A/ $\mu\text{s}$ |

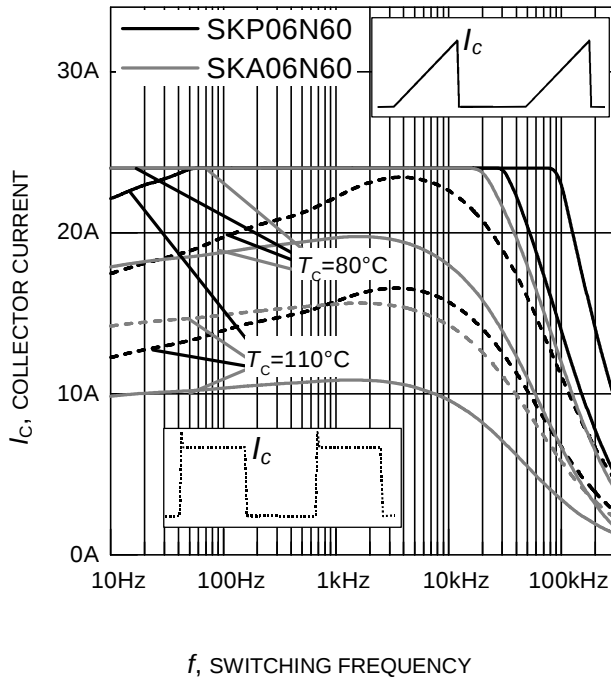
**Switching Characteristic, Inductive Load, at  $T_j=150^\circ\text{C}$**

| Parameter              | Symbol       | Conditions                                                                                                                                                                                                                                            | Value |       |       | Unit |
|------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------|-------|------|
|                        |              |                                                                                                                                                                                                                                                       | min.  | typ.  | max.  |      |
| IGBT Characteristic    |              |                                                                                                                                                                                                                                                       |       |       |       |      |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=150^{\circ}\text{C}$<br>$V_{CC}=400\text{V}, I_C=6\text{A},$<br>$V_{GE}=0/15\text{V},$<br>$R_G=50\Omega,$<br>$L_{\sigma}^{1)}=180\text{nH},$<br>$C_{\sigma}^{1)}=250\text{pF}$<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -     | 24    | 29    | ns   |
| Rise time              | $t_r$        |                                                                                                                                                                                                                                                       | -     | 17    | 20    |      |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                                                                                       | -     | 248   | 298   |      |
| Fall time              | $t_f$        |                                                                                                                                                                                                                                                       | -     | 70    | 84    |      |
| Turn-on energy         | $E_{on}$     |                                                                                                                                                                                                                                                       | -     | 0.167 | 0.192 | mJ   |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                                                                                       | -     | 0.153 | 0.199 |      |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                                                                                       | -     | 0.320 | 0.391 |      |

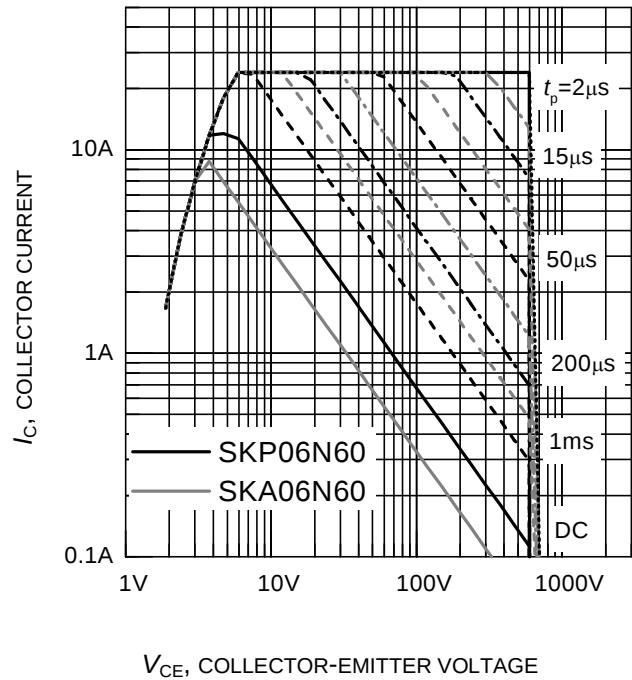
**Anti-Parallel Diode Characteristic**

|                                                                  |              |                                                                                                       |   |     |   |                  |
|------------------------------------------------------------------|--------------|-------------------------------------------------------------------------------------------------------|---|-----|---|------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_j=150^\circ\text{C}$<br>$V_R=200\text{V}$ , $I_F=6\text{A}$ ,<br>$di_F/dt=200\text{A}/\mu\text{s}$ | - | 290 | - | ns               |
|                                                                  | $t_S$        |                                                                                                       | - | 27  | - |                  |
|                                                                  | $t_F$        |                                                                                                       | - | 263 | - |                  |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                       | - | 500 | - | nC               |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                       | - | 5.0 | - | A                |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |                                                                                                       | - | 200 | - | A/ $\mu\text{s}$ |

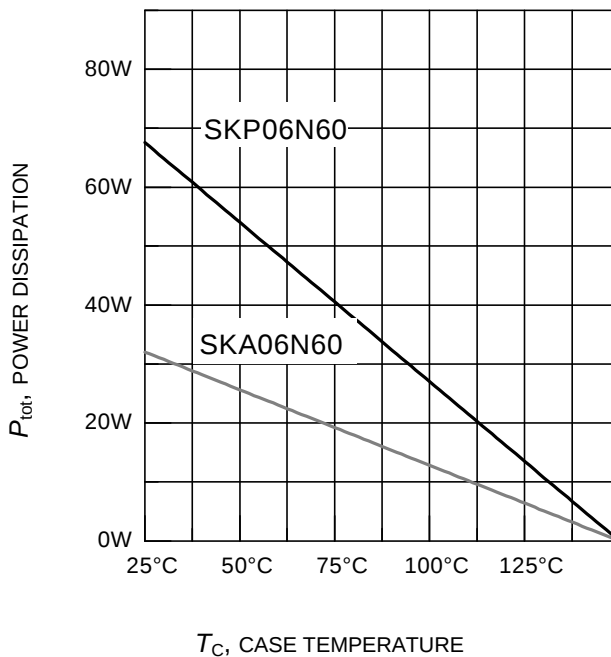
<sup>1)</sup> Leakage inductance  $L_{\sigma}$  and Stray capacity  $C_{\sigma}$  due to dynamic test circuit in Figure E.



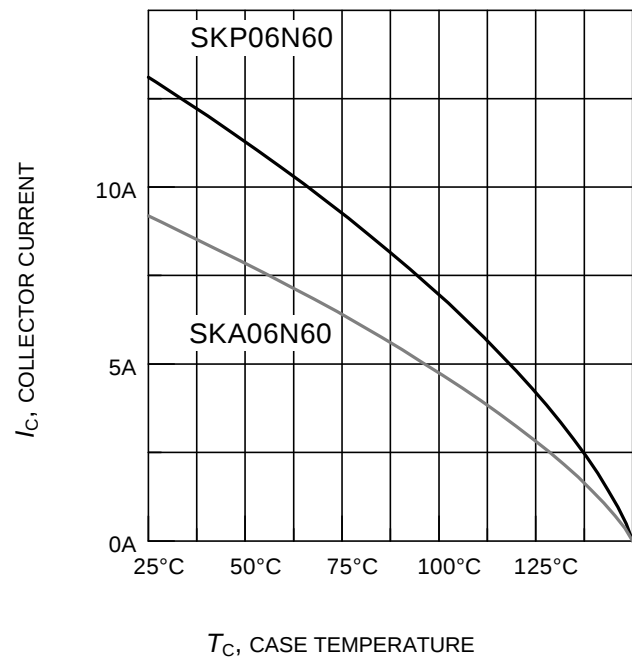
**Figure 1. Collector current as a function of switching frequency**  
 $(T_j \leq 150^\circ\text{C}, D = 0.5, V_{CE} = 400\text{V}, V_{GE} = 0/+15\text{V}, R_G = 50\Omega)$



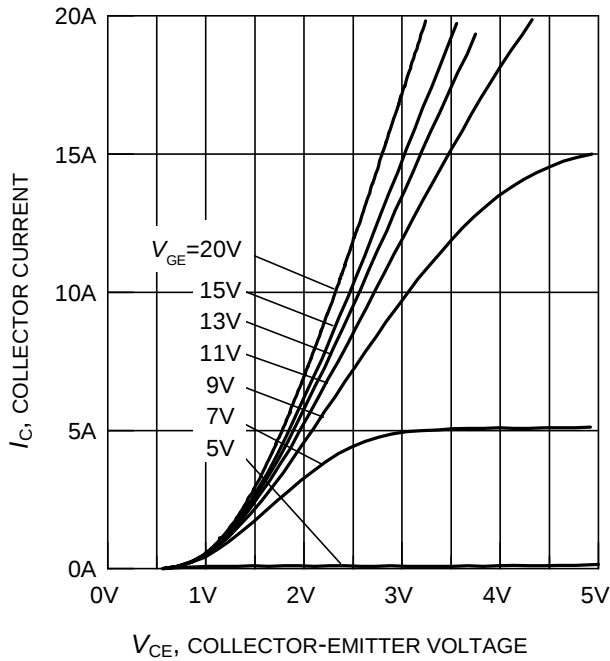
**Figure 2. Safe operating area**  
 $(D = 0, T_C = 25^\circ\text{C}, T_j \leq 150^\circ\text{C})$



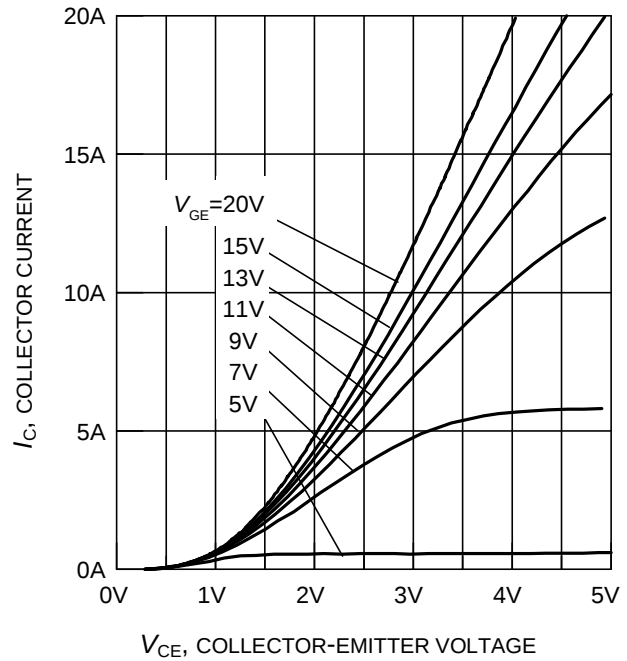
**Figure 3. Power dissipation as a function of case temperature**  
 $(T_j \leq 150^\circ\text{C})$



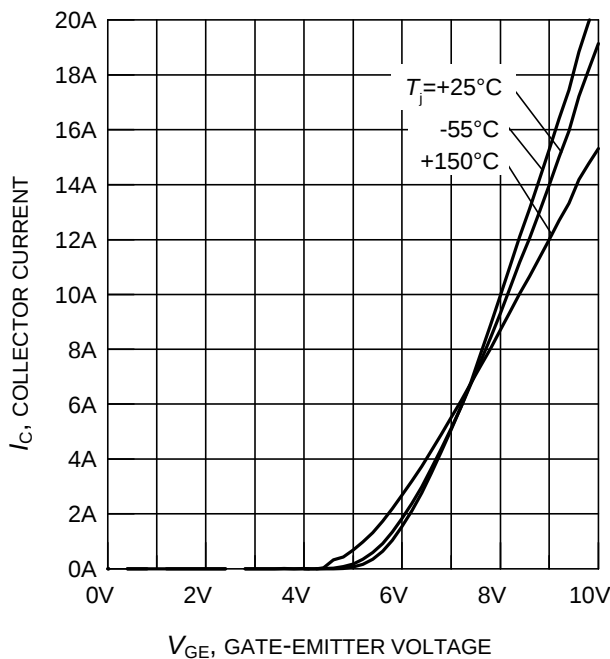
**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \leq 15\text{V}, T_j \leq 150^\circ\text{C})$



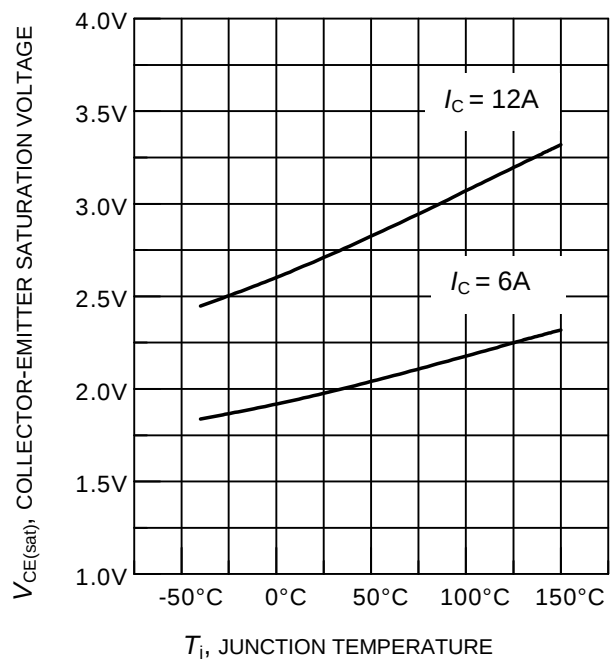
**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



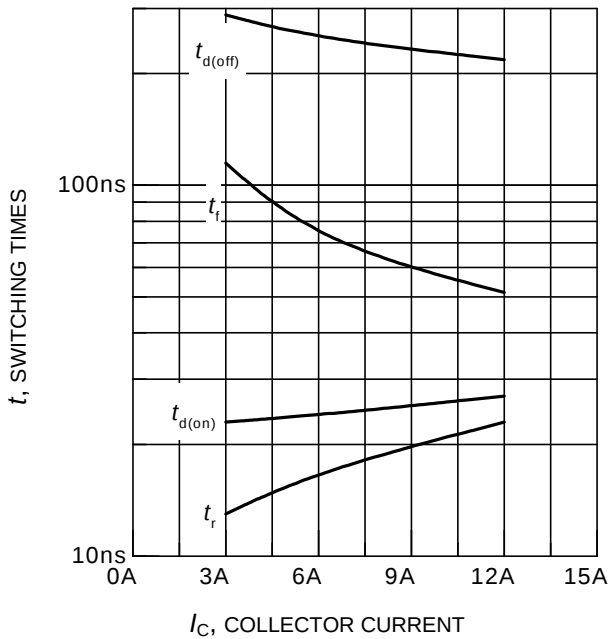
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



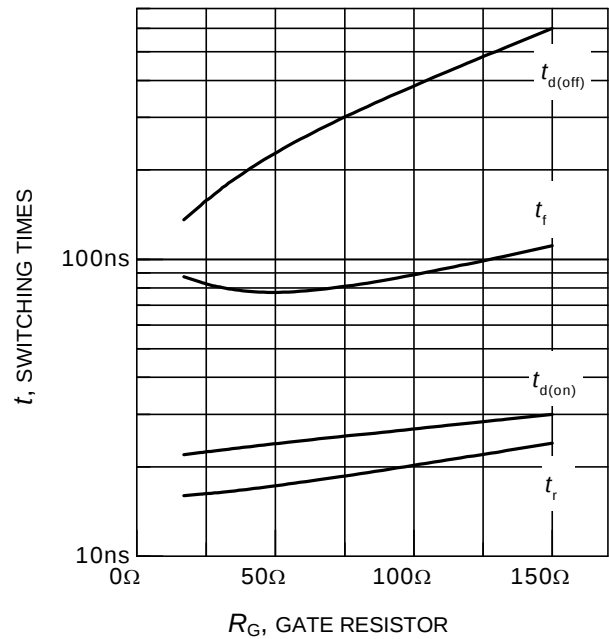
**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 10\text{V}$ )



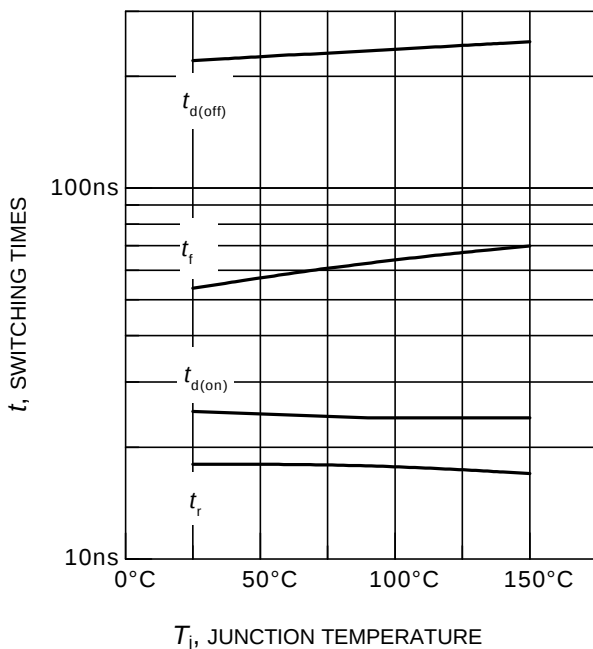
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



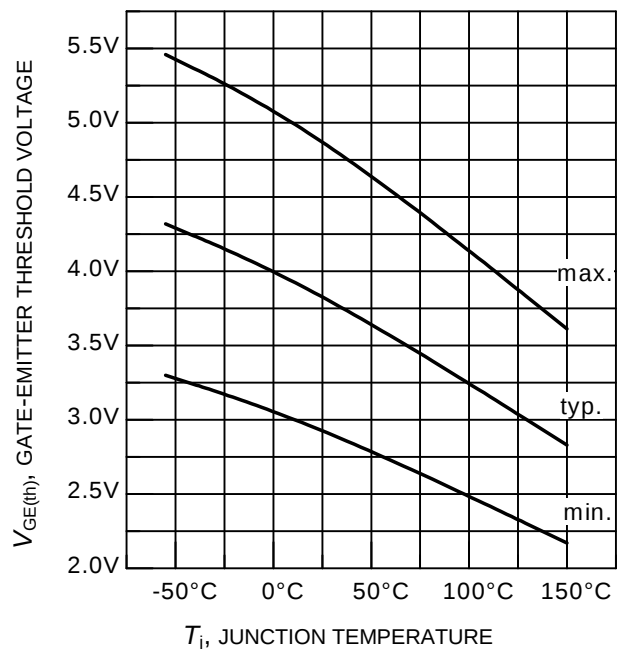
**Figure 9. Typical switching times as a function of collector current**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $R_G = 50\Omega$ , Dynamic test circuit in Figure E)



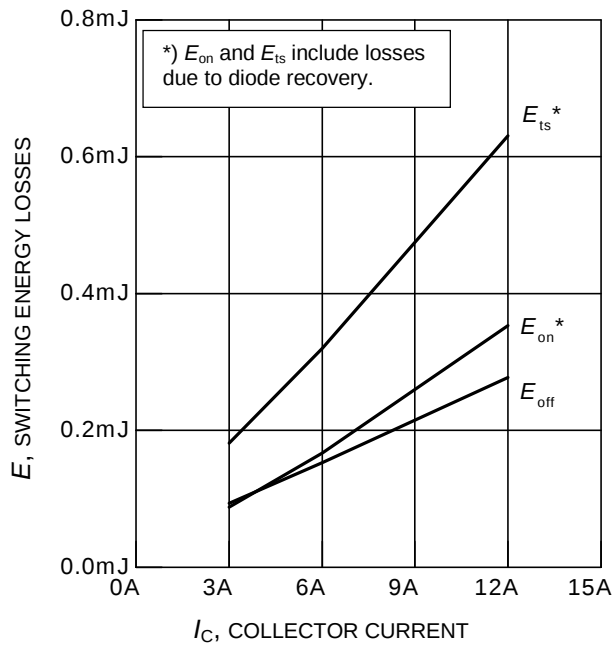
**Figure 10. Typical switching times as a function of gate resistor**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 6\text{A}$ , Dynamic test circuit in Figure E)



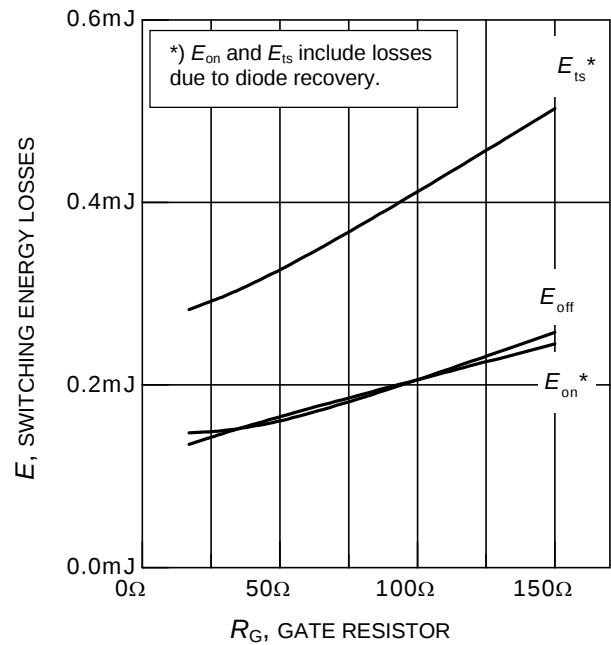
**Figure 11. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 6\text{A}$ ,  $R_G = 50\Omega$ , Dynamic test circuit in Figure E)



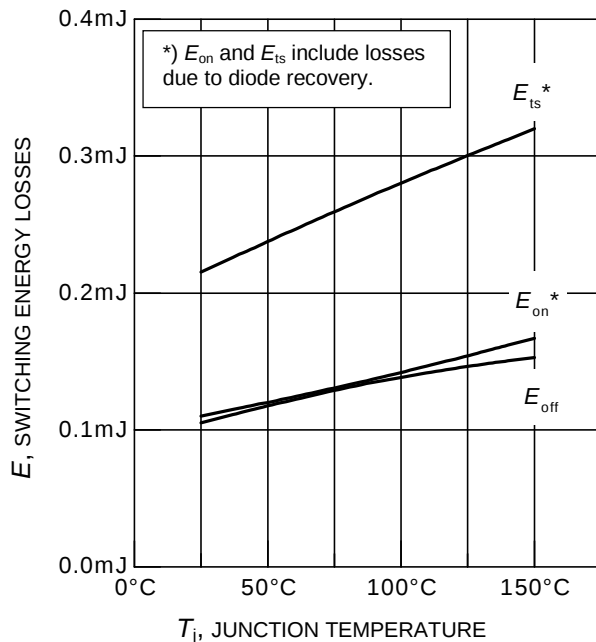
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C = 0.25\text{mA}$ )



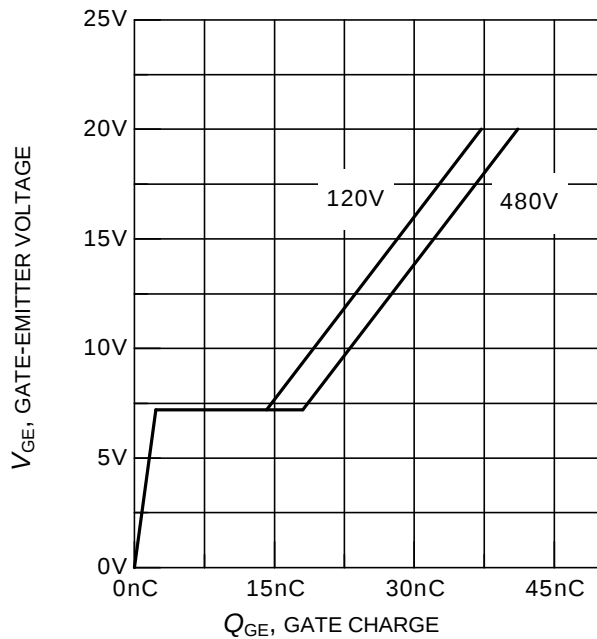
**Figure 13. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $R_G = 50\Omega$ , Dynamic test circuit in Figure E)



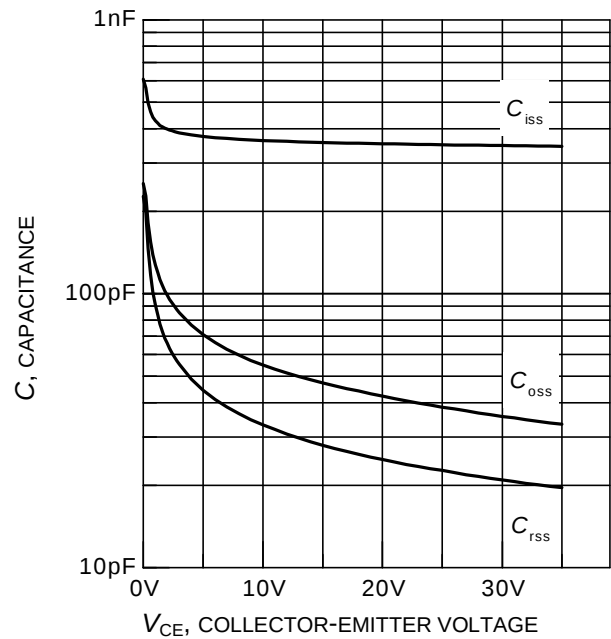
**Figure 14. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 6\text{A}$ , Dynamic test circuit in Figure E)



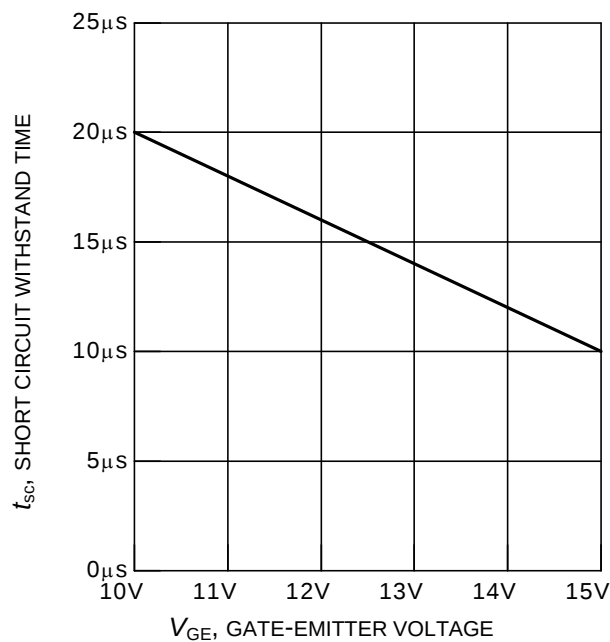
**Figure 15. Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 6\text{A}$ ,  $R_G = 50\Omega$ , Dynamic test circuit in Figure E)



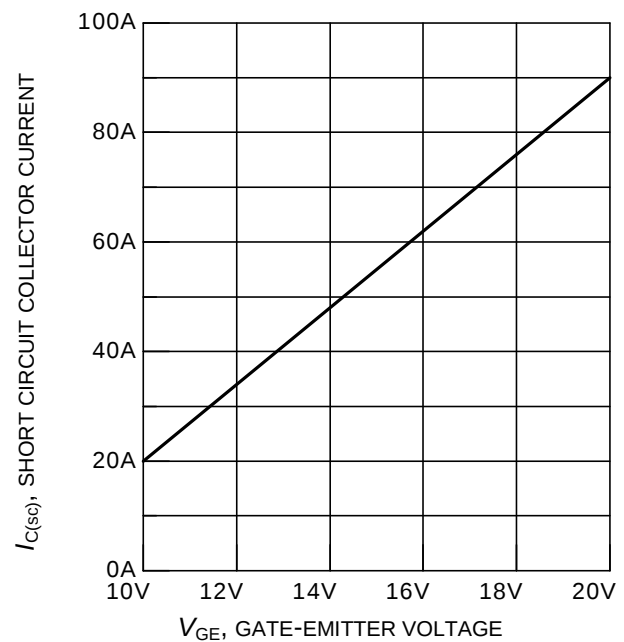
**Figure 16. Typical gate charge**  
( $I_C = 6A$ )



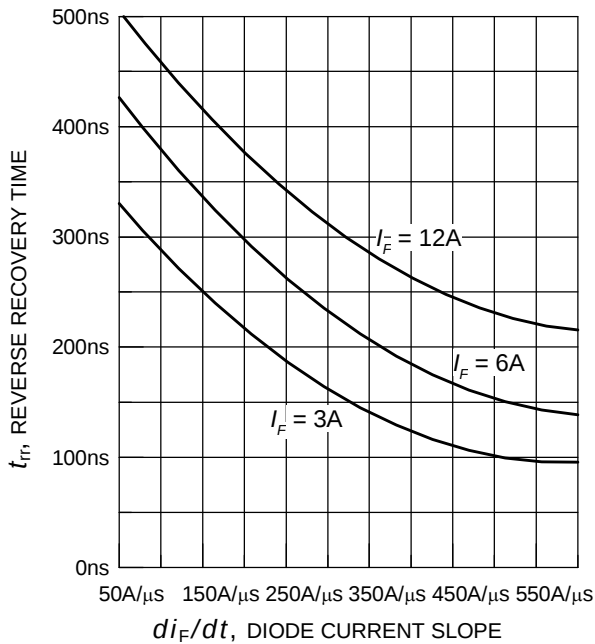
**Figure 17. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V$ ,  $f = 1MHz$ )



**Figure 18. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} = 600V$ , start at  $T_j = 25^\circ C$ )

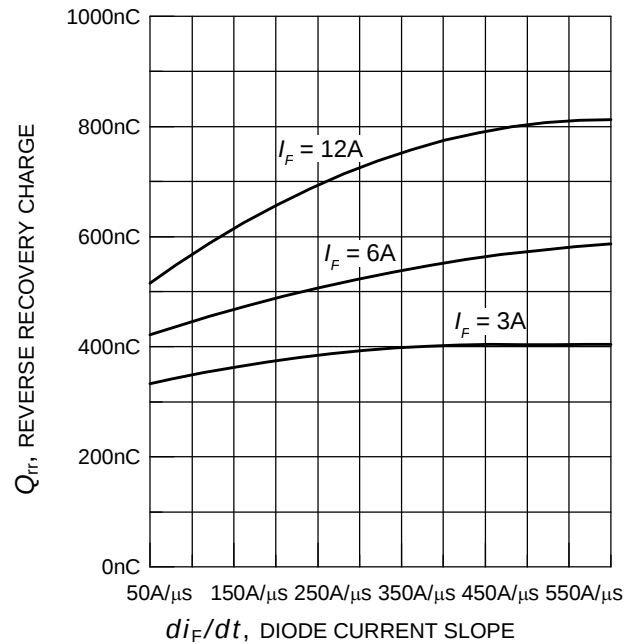


**Figure 19. Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 600V$ ,  $T_j = 150^\circ C$ )



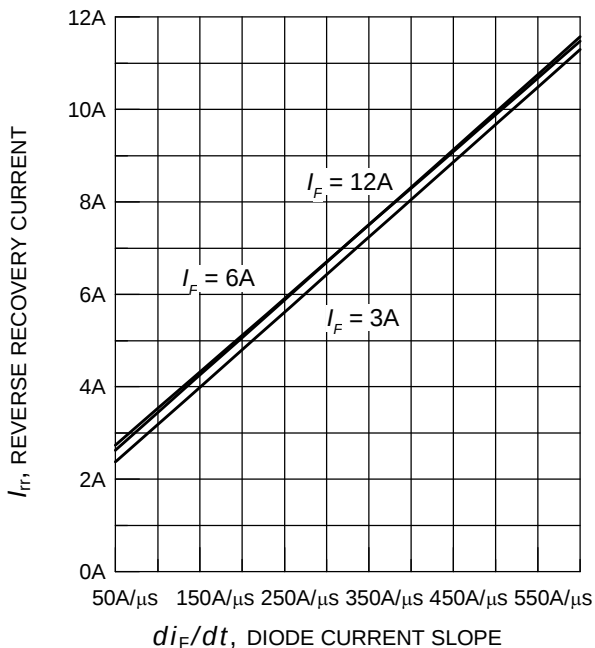
**Figure 20. Typical reverse recovery time as a function of diode current slope**

( $V_R = 200V$ ,  $T_j = 125^\circ C$ ,  
Dynamic test circuit in Figure E)



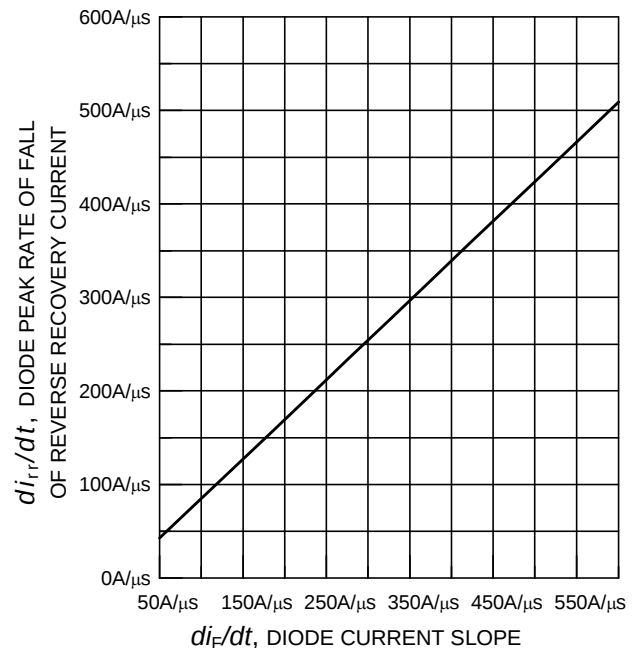
**Figure 21. Typical reverse recovery charge as a function of diode current slope**

( $V_R = 200V$ ,  $T_j = 125^\circ C$ ,  
Dynamic test circuit in Figure E)



**Figure 22. Typical reverse recovery current as a function of diode current slope**

( $V_R = 200V$ ,  $T_j = 125^\circ C$ ,  
Dynamic test circuit in Figure E)



**Figure 23. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

( $V_R = 200V$ ,  $T_j = 125^\circ C$ ,  
Dynamic test circuit in Figure E)

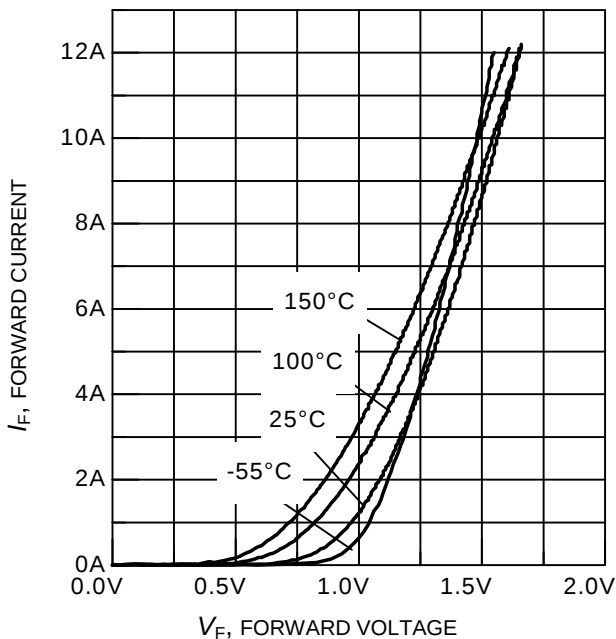


Figure 24. Typical diode forward current as a function of forward voltage

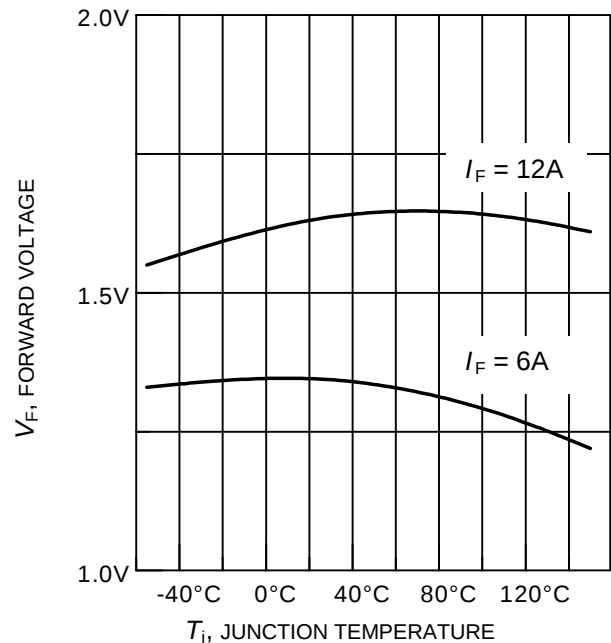


Figure 25. Typical diode forward voltage as a function of junction temperature

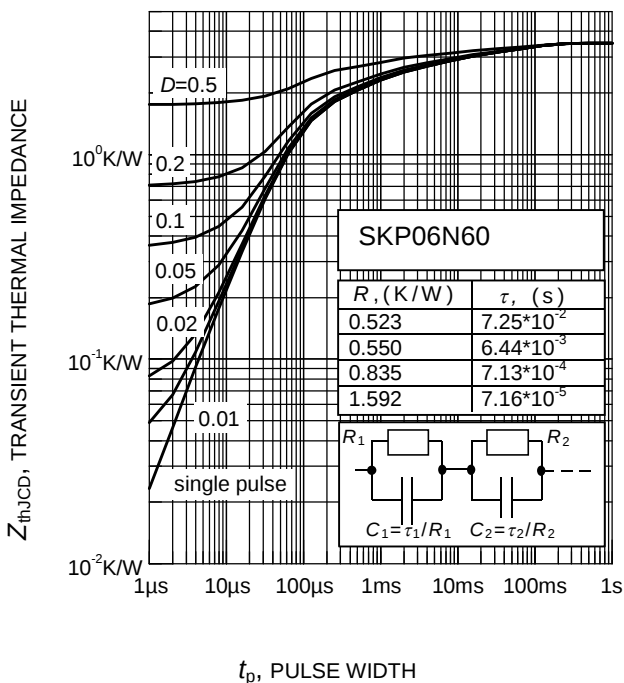


Figure 26. Diode transient thermal impedance as a function of pulse width ( $D = t_p / T$ )

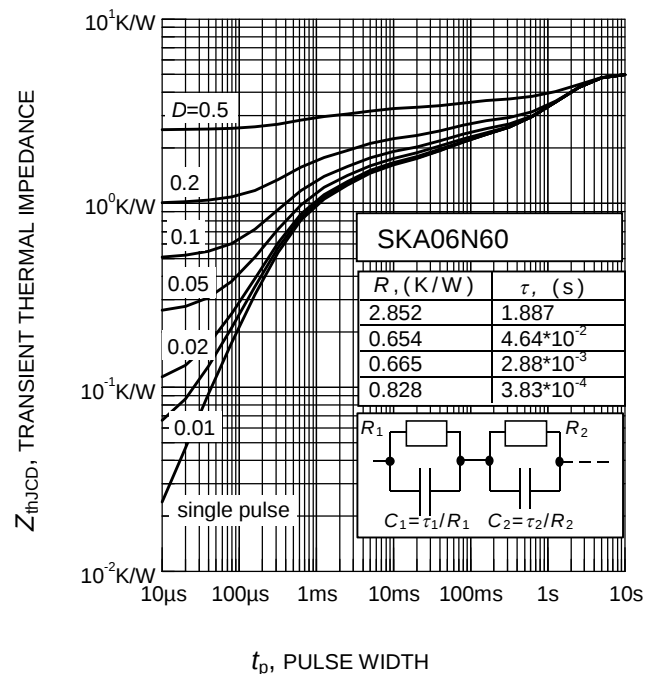
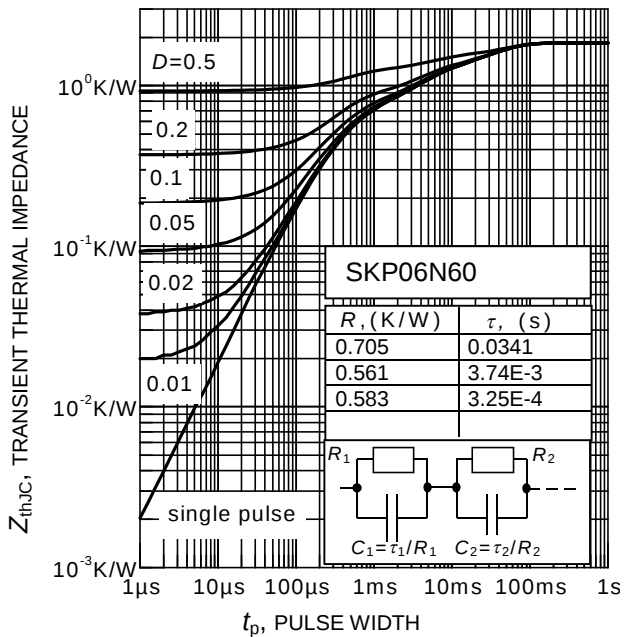
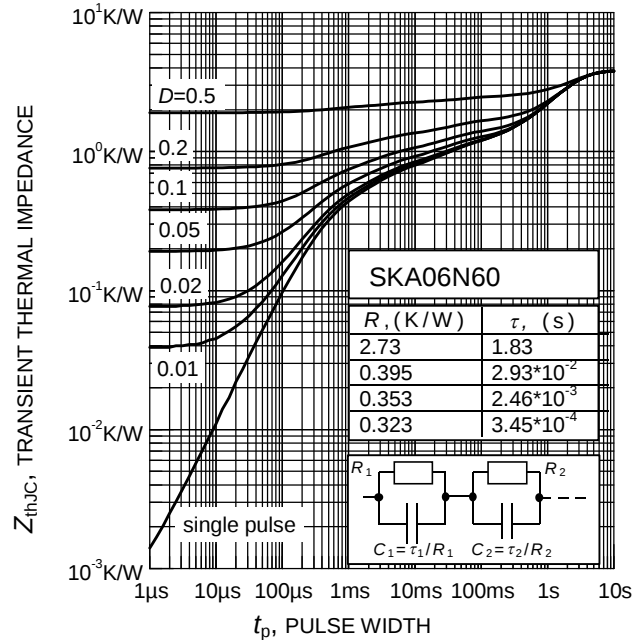


Figure 27. Diode transient thermal impedance as a function of pulse width ( $D = t_p / T$ )

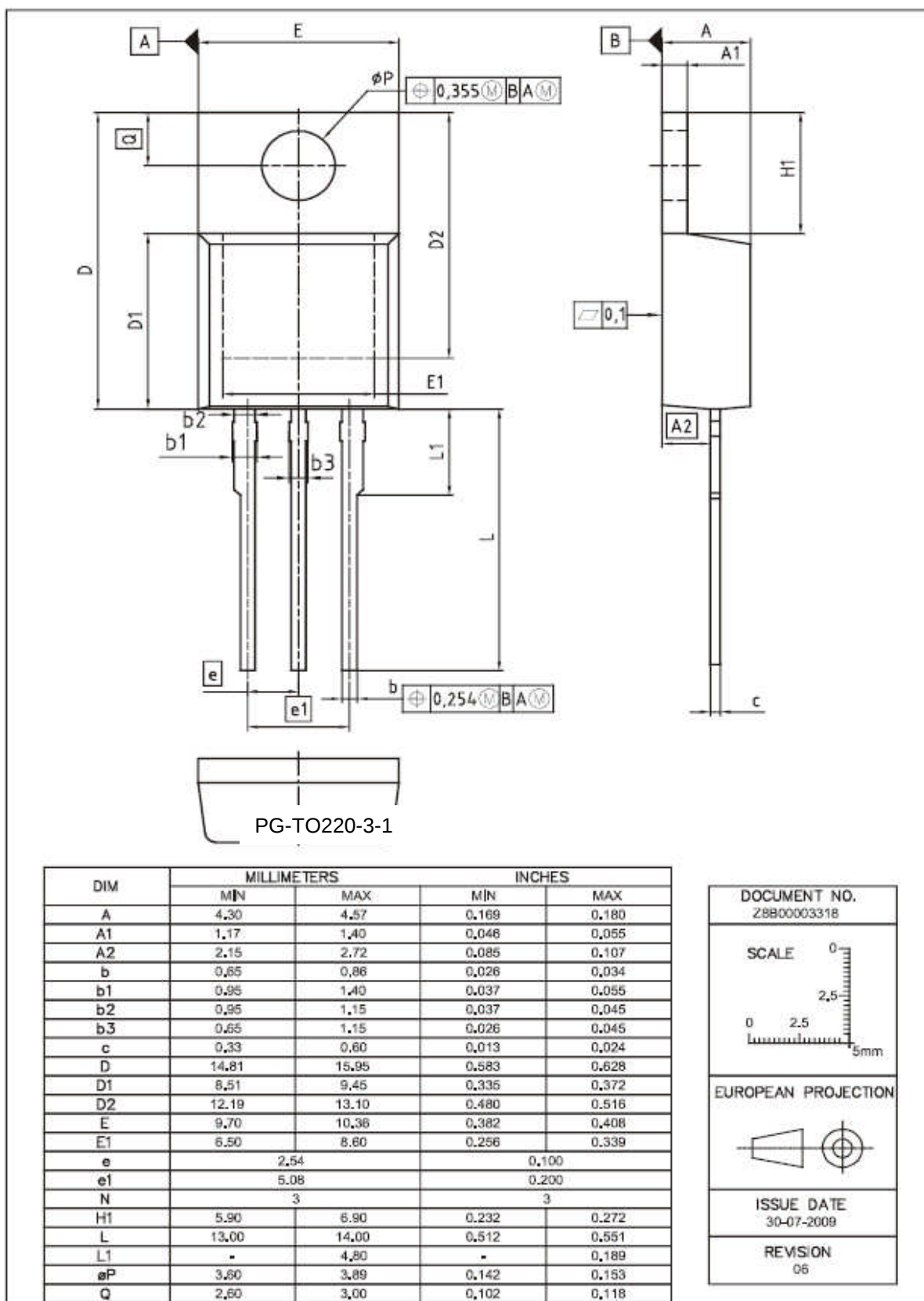


**Figure 28. IGBT transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )

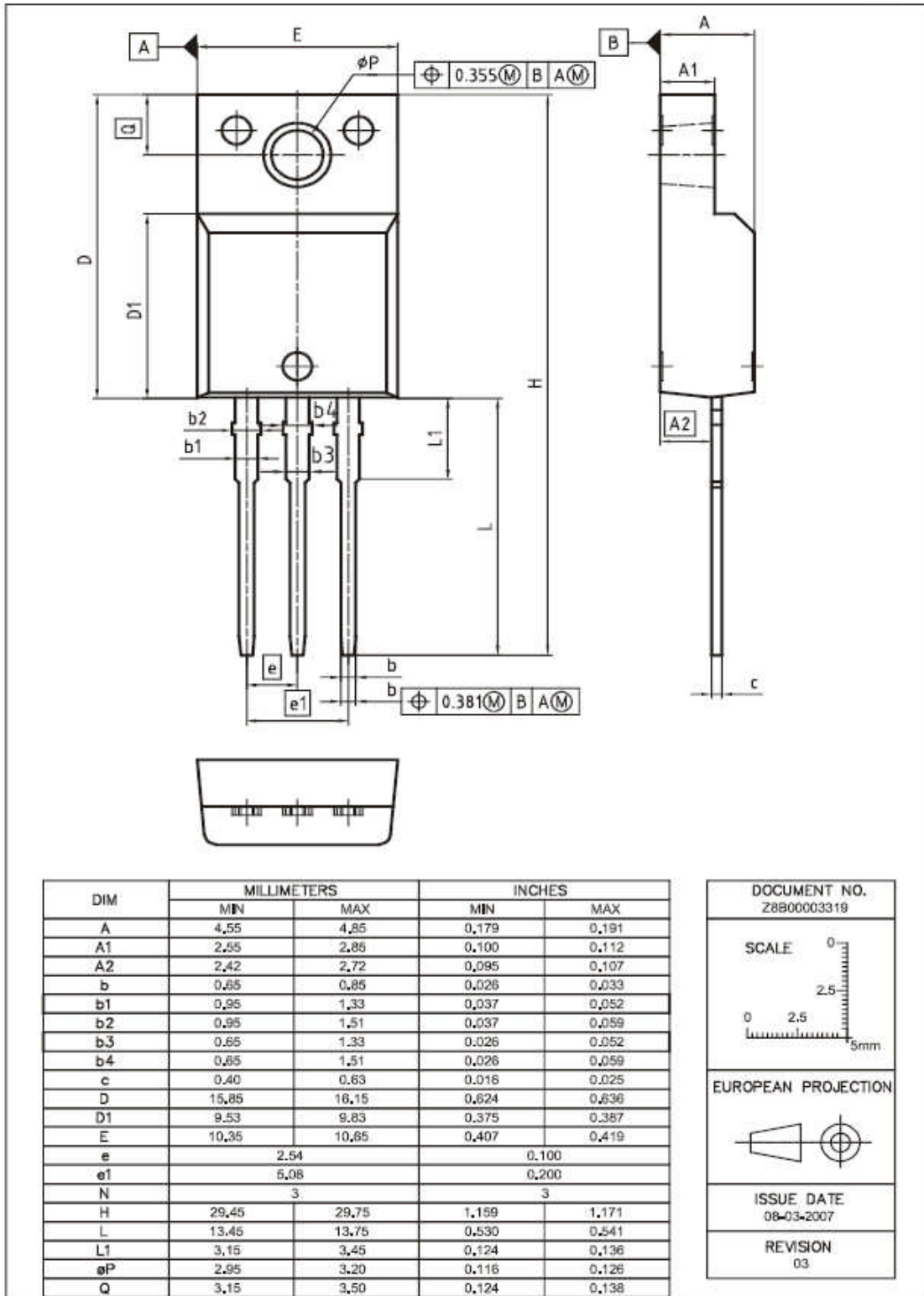


**Figure 29. IGBT transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )

PG-TO220-3



PG-TO220-3-FP



Please refer to mounting instructions

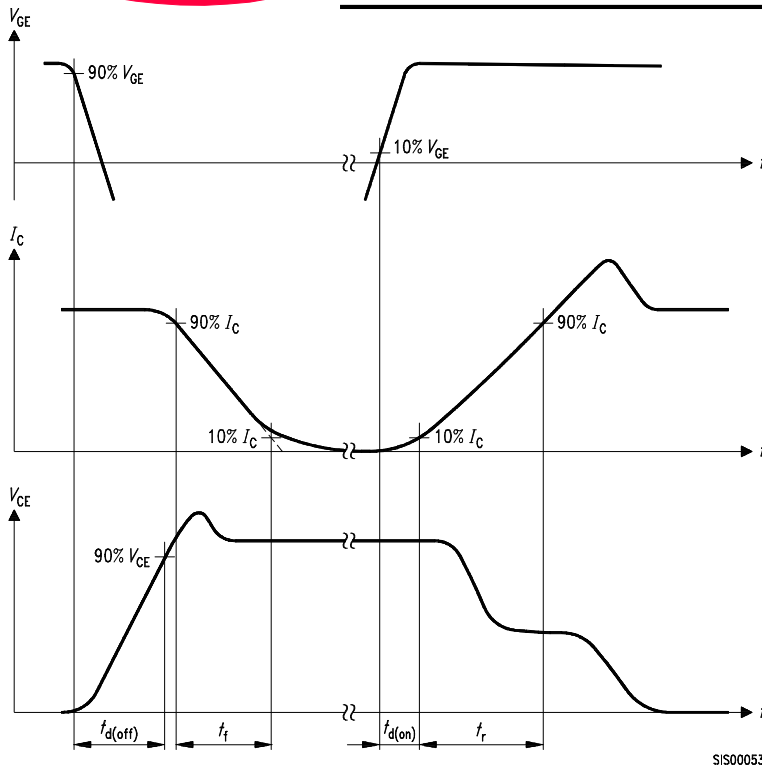


Figure A. Definition of switching times

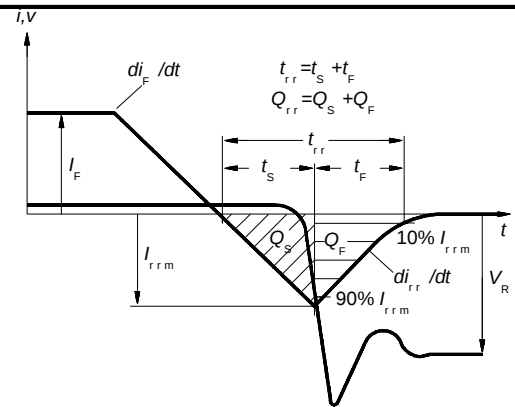


Figure C. Definition of diodes switching characteristics

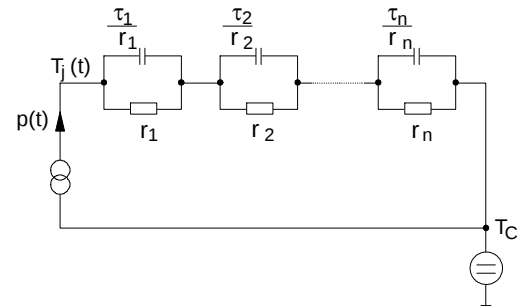


Figure D. Thermal equivalent circuit

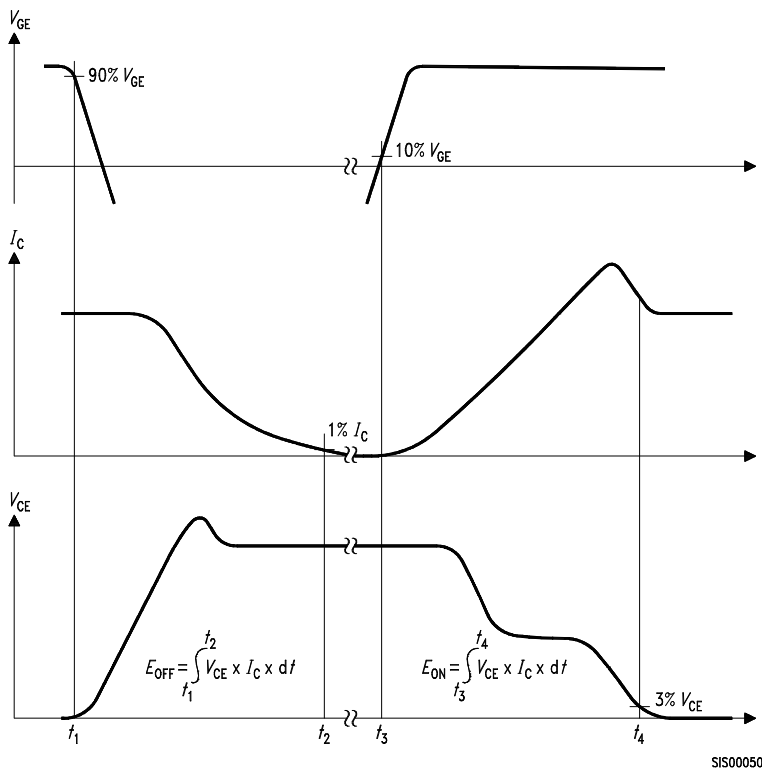


Figure B. Definition of switching losses

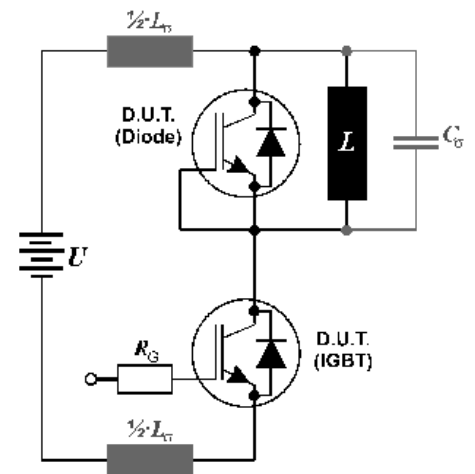


Figure E. Dynamic test circuit  
Leakage inductance  $L_\sigma = 180\text{nH}$   
and Stray capacity  $C_\sigma = 250\text{pF}$ .

**Published by**  
**Infineon Technologies AG**  
**81726 Munich, Germany**  
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